

1AP8 Rec'd PCT/PTO 17 JUL 2007

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APPLICATION FORM COVER SHEET

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11/795388

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2.17.07

<b>1. Name of conveying party(ies):</b> Yasuhito KINPORA (05/23/2007) and Makoto IIDA (05/23/2007)  Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	<b>2. Name and address of receiving party(ies)</b> Name: <u>PS Japan Corporation</u> Internal Address: _____ Street Address: _____
<b>3. Nature of conveyance/Execution Date(s):</b> Execution Date(s): <u>in parentheses after inventor name</u> <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Change of Name <input type="checkbox"/> Security Agreement <input type="checkbox"/> Joint Research Agreement <input type="checkbox"/> Government Interest Assignment <input type="checkbox"/> Executive Order 9424, Confirmatory License <input type="checkbox"/> Other _____	4-1, Koishikawa 1-chome, Bunkyo-ku Tokyo JAPAN  City: _____ State: _____ Country: _____ Zip: _____ Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
<b>4. Application or patent number(s):</b> <input checked="" type="checkbox"/> This document is being filed together with a new application. A. Patent Application No.(s) <u>NEW</u> B. Patent No.(s) <u>11/795388</u>  Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
<b>5. Name and address to whom correspondence concerning document should be mailed:</b> Name: <u>John W. Bailey</u> <u>BIRCH, STEWART, KOLASCH &amp; BIRCH, LLP</u>  Internal Address: <u>Atty. Dkt.: 0152-0769PUS1</u> Street Address: <u>8110 Gatehouse Road</u> <u>Suite 100 East</u> <u>P.O. Box 747</u>  City: <u>Falls Church</u> State: <u>VA</u> Zip: <u>22040-0747</u> Phone Number: <u>(703) 205-8000</u> Fax Number: <u>(703) 205-8050</u> Email Address: <u>mailroom@bskb.com</u>	<b>6. Total number of applications and patents involved:</b> <span style="border: 1px solid black; padding: 2px;">1</span>  <b>7. Total fee (37 CFR 1.21(h) &amp; 3.41) \$</b> <u>40.00</u> <input type="checkbox"/> Authorized to be charged by credit card <input checked="" type="checkbox"/> Authorized to be charged to deposit account <input type="checkbox"/> Enclosed <input type="checkbox"/> None required (government interest not affecting title)  <b>8. Payment Information</b> a. Credit Card Last 4 Numbers _____ Expiration Date _____ b. Deposit Account Number <u>02-2448</u> Authorized User Name <u>John W. Bailey</u>
<b>9. Signature:</b>  #42-874 Signature _____ Date <u>July 17, 2007</u> <u>John W. Bailey - 32,881</u> Name of Person Signing Total number of pages including cover sheet, attachments, and documents: <span style="border: 1px solid black; padding: 2px;">2</span>	

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Birch, Stewart, Kolasch & Birch, LLP

JWB//scp

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REEL: 019596 FRAME: 0997

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ASSIGNMENT AP8 Rec'd PCT/PTO 17 JUL 2007

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by PS Japan Corporation, a corporation organized under the laws of Japan, located at 4-1, Koishikawa 1-chome, Bunkyo-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said PS Japan Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said PS Japan Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said PS Japan Corporation.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

Date Signed

WITNESSES

(発明者フルネームサイン)

(署名日)

(立会人サイン)

1)	<u>Yasuhito Kinpara</u> Yasuhito KINPARA	<u>May 23, 2007</u>	<u>Ryozo Okumura</u>
2)	<u>Makoto Iida</u> Makoto IIDA	<u>May 23, 2007</u>	<u>Ryozo Okumura</u>
3)	_____	_____	_____
4)	_____	_____	_____
5)	_____	_____	_____
6)	_____	_____	_____
7)	_____	_____	_____
8)	_____	_____	_____
9)	_____	_____	_____

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